1735481-4 ✓ ACTIVE

Free Height

TE Internal #: 1735481-4

PCB Mount Receptacle, Vertical, Board-to-Board, 100 Position, .8 mm [.031 in] Centerline, Gold, Surface Mount, Signal, Natural, Free

Height

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Free Height Receptacle Conn: Board-Board, Vertical, 100, 0.8mm



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 100

Centerline (Pitch): .8 mm [.031 in]

All Free Height Receptacle Conn: Board-Board, Vertical, 100, 0.8mm (24)

Features

Product Type Features

| PCB Connector Assembly Type | PCB Mount Receptacle |
|-----------------------------------|-----------------------|
| Connector System | Board-to-Board |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Stackable | Yes |
|------------------------------|----------|
| PCB Mount Orientation | Vertical |
| Number of Positions | 100 |
| Board-to-Board Configuration | Parallel |

Electrical Characteristics

| Dielectric Withstanding Voltage (Max) | 500 VAC |
|---------------------------------------|---------|
| Insulation Resistance | 2 ΜΩ |
| Operating Voltage | 100 VAC |

Body Features

| Assembly Process Feature Material | Steel |
|-----------------------------------|---------|
| Primary Product Color | Natural |



Contact Features

| PCB Contact Termination Area Plating Material Thickness | 2 μm[78.74 μin] |
|---------------------------------------------------------|-----------------|
| Contact Layout | Inline |
| Mating Tab Width | .8 mm[.031 in] |
| Mating Tab Thickness | .25 mm[.01 in] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Copper Alloy |
| Contact Mating Area Plating Material | Gold |
| | 8 µin |
| Contact Type | Socket |
| Contact Current Rating (Max) | .5 A |

Termination Features

| Rectangular Termination Post & Tail Thickness | .2 mm[.008 in] |
|-----------------------------------------------|----------------|
| Rectangular Termination Post & Tail Width | .3 mm[.012 in] |
| Termination Method to Printed Circuit Board | Surface Mount |

Mechanical Attachment

| Mounting Alignment Feature Length | .5 mm[.02 in] |
|-----------------------------------|--------------------|
| PCB Mount Alignment Type | Positioning Bosses |
| Mating Alignment | With |
| Mating Alignment Type | Polarized |
| PCB Mount Retention | Without |
| PCB Mount Alignment | With |
| Connector Mounting Type | Board Mount |

Housing Features

| Mating Entry Location | Тор |
|-----------------------|----------------|
| Centerline (Pitch) | .8 mm[.031 in] |
| Housing Material | Matte |

Dimensions

| Connector Height | 17 mm[.669 in] |
|------------------|----------------------------------------------------------------|
| Stack Height | 17 mm, 18 mm, 19 mm, 20 mm[.669 in][.709 in][.748 in][.787 in] |

Usage Conditions



| Housing Temperature Rating | High |
|-----------------------------|----------------------------|
| Operating Temperature Range | -40 - 125 °C[-40 - 257 °F] |
| Operation/Application | |
| Assembly Process Feature | Pick and Place Cover |
| Circuit Application | Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| Packaging Features | |
| | .5 in |
| Packaging Quantity | 10 |
| Packaging Type | Box, Tube |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|-----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
| Solder Process Capability | Reflow solder capable to 260°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach



Compatible Parts



Also in the Series | Free Height

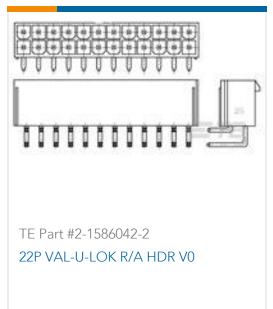


Customers Also Bought















Documents

Product Drawings
0.8FH,R17H.5,100,08/Sn,TU,SC

English

CAD Files



Customer View Model

ENG_CVM_CVM_1735481-4_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1735481-4_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1735481-4_A.3d_stp.zip

English

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Product Specifications

Product Specification

English

Product Specification

English